

Is Now Part of



### **ON Semiconductor**®

### To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="mailto:www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to <a href="mailto:Fairchild\_questions@onsemi.com">Fairchild\_questions@onsemi.com</a>.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or unavteries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor and is officers, employees, uniotificated use, even if such claim any manner.

March 2015



### 30V N-Channel PowerTrench<sup>o</sup> MOSFET

#### **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on state resistance and yet maintain low gate charge for superior switching performance.

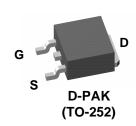
#### Applications

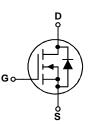
- DC/DC converter
- Motor Drives

### Features

• 12 A, 30 V 
$$R_{DS(ON)} = 14.5 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$$
  
 $R_{DS(ON)} = 21 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$ 

- Low gate charge
- Fast Switching Speed
- High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$





#### Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Para	meter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage			30	V
V <sub>GSS</sub>	Gate-Source Voltage			±20	V
ID	Continuous Drain Current	@T <sub>c</sub> =25°C	(Note 3)	50	А
		@T <sub>A</sub> =25°C	(Note 1a)	12	
		Pulsed	(Note 1a)	100	
PD	Power Dissipation	@T <sub>c</sub> =25°C	(Note 3)	56	W
		@T <sub>A</sub> =25°C	(Note 1a)	3.2	
		@T <sub>A</sub> =25°C	(Note 1b)	1.5	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Ju	nction Tempera	ture Range	-55 to +175	°C
Therma	I Characteristics		·		·
R <sub>θJC</sub>	Thermal Resistance, Junc	tion-to-Case	(Note 1)	2.7	°C/W

$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	2.7	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	45	
$R_{ ext{ heta}JA}$		(Note 1b)	96	

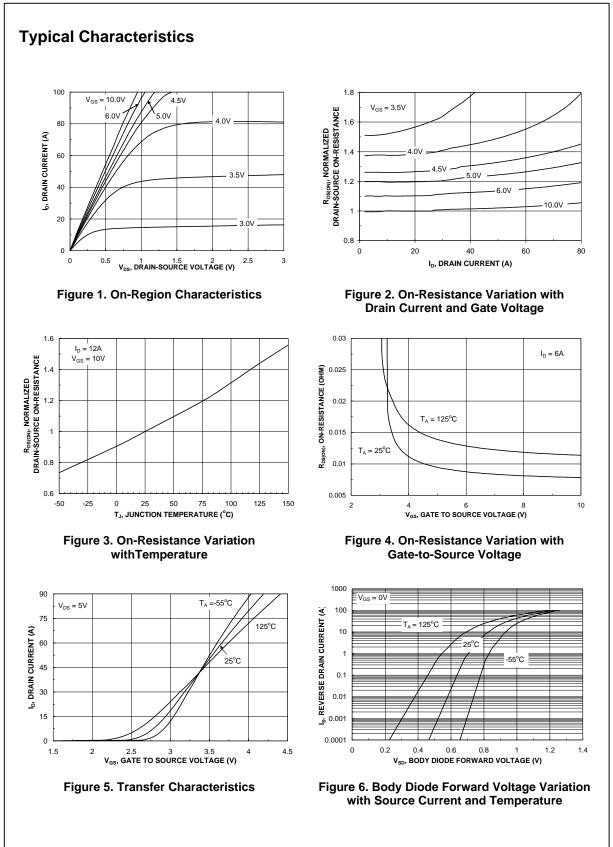
#### Package Marking and Ordering Information

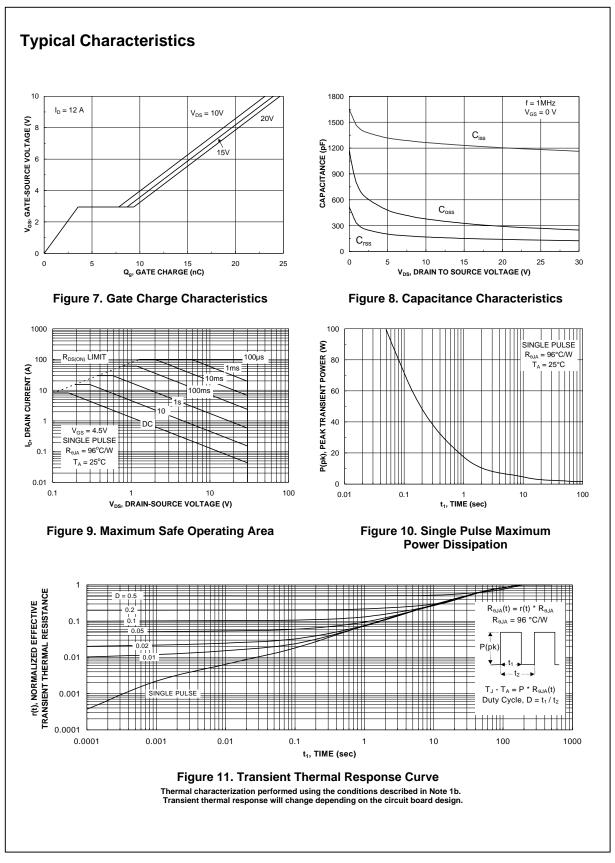
FDD6030L FDD6030L D-PAK (TO-252) 13" 16mm 2500 units	Device Marking	Device	Package	Reel Size	Tape width	Quantity
	FDD6030L	FDD6030L	D-PAK (TO-252)	13"	16mm	2500 units

©2003 Fairchild Semiconductor Corporation

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-So	ource Avalanche Ratings (Note	2)	•			
E <sub>AS</sub>	Drain-Source Avalanche Energy	Single Pulse, $V_{DD} = 15 \text{ V}$ , $I_D = 12 \text{ A}$			100	mJ
I <sub>AS</sub>	Drain-Source Avalanche Current				12	Α
Off Char	acteristics					
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$ , $I_{D} = 250 \mu A$	30			V
<u>ΔBV<sub>DSS</sub></u> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A,Referenced to 25°C		24		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V},  V_{GS} = 0 \text{ V}$			1	μA
I <sub>GSS</sub>	Gate-Body Leakage	$V_{GS} = \pm 20 \text{ V},  V_{DS} = 0 \text{ V}$			±100	nA
On Char	acteristics (Note 2)	·				
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1	1.9	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A,Referenced to 25°C		-5		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance			7.7 9.9 11.4	14.5 21 25	mΩ
I <sub>D(on)</sub>	On-State Drain Current	$V_{GS} = 10 \text{ V},  V_{DS} = 5 \text{ V}$	50			А
<b>g</b> <sub>FS</sub>	Forward Transconductance	$V_{DS} = 10 \text{ V}, \qquad I_D = 12 \text{ A}$		47		S
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			1230		pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 15 V, V_{GS} = 0 V,$		325		pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1.0 MHz		150		pF
R <sub>G</sub>	Gate Resistance	$V_{GS} = 15 \text{ mV}, \text{ f} = 1.0 \text{ MHz}$		1.5		pF
Switchin	g Characteristics (Note 2)		•		•	•
t <sub>d(on)</sub>	Turn–On Delay Time			10	19	ns
tr	Turn–On Rise Time	$V_{DD} = 15 V, I_D = 1 A,$		7	13	ns
t <sub>d(off)</sub>	Turn–Off Delay Time	$V_{GS} = 10 \text{ V},  R_{GEN} = 6 \Omega$		29	46	ns
t <sub>f</sub>	Turn–Off Fall Time	1		12	21	ns
Qg	Total Gate Charge			13	28	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{DS} = 15V$ , $I_D = 12 A$ , $V_{GS} = 5 V$		3.5		nC
Q <sub>gd</sub>	Gate-Drain Charge			5.1		nC

	uous Drain–Source ode Forward Voltage ecovery Time ecovery Charge	Diode Forward $V_{GS} = 0 V,$	Current		0.76	2.7	AV
S Maximum Continu   V <sub>SD</sub> Drain–Source Dio   Grr Diode Reverse Re   Qrr Diode Reverse Re   Dtest R <sub>BJA</sub> is the sum of the junction-to-case and	uous Drain–Source ode Forward Voltage ecovery Time ecovery Charge	Diode Forward $V_{GS} = 0 V,$	Current I <sub>S</sub> = 2.7 A (Note 2)		0.76		
Joan Drain–Source Diod   rr Diode Reverse Re   Qrr Diode Reverse Re   tes: Raya is the sum of the junction-to-case and	ode Forward Voltage ecovery Time ecovery Charge	e V <sub>GS</sub> = 0 V,	I <sub>S</sub> = 2.7 A (Note 2)		0.76	1.2	V
rr Diode Reverse Re Qrr Diode Reverse Re otes: R <sub>gJA</sub> is the sum of the junction-to-case and	ecovery Time ecovery Charge						V
Diode Reverse Re   otes:   R <sub>0JA</sub> is the sum of the junction-to-case and	ecovery Charge				24		nS
otes: R <sub>eJA</sub> is the sum of the junction-to-case and					13		nC
	sign while R <sub>eCA</sub> is determin a) R <sub>eJA</sub> = 45°C/W w	ed by the user's bo /hen mounted on a	ne case thermal reference i ard design.	b) R <sub>θJA</sub>	= 96°C/W	when mour	
-	1in <sup>2</sup> pad of 2 oz (		-	on a	minimum p	oad.	
Pulse Test: Pulse Width < 300µs, Duty Cy	vcle < 2.0%	Scale 1 : 1 on lett	er size paper				
Maximum current is calculated as:	$\sqrt{\frac{B}{R_{DS(ON)}}}$						





FDD6030L Rev. 2.3



ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC